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Patent and Trademark Office 103368182 orable Commissioner of a define and a rademarks: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies) 1. Name of conveying parties Toshiki SHIMIZU, Jumpei KURA, Mariko FUKUYAMA SONY CORPORATION 7-35 Kitashinagawa 6-chome Additional name(s) of conveying party(ies) Shinagawa-Ku, Tokyo 141-0001, Japan attached? Yes X No And 3. Nature of conveyance: X Assignment Additional name(s) & address(es) attached? ___ Yes Security Agreement Merger Change of Name Other Execution Date(s): January 15, January 15 and January 17, 2007. 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: ___ A. Patent Application No. 11/592,482 filed November 3, 2006. Additional numbers attached? ___ Yes __X No 6. Total number of applications and patents involved 5. Name and address of party to whom correspondence concerning 1 document should be mailed: \$ 40.00 7. Total fee (37 CFR 3.41) Name: WILLIAM S. FROMMER X Enclosed Internal Address: FROMMER LAWRENCE & HAUG LLP Authorized to be charged to deposit account 50-0320 Street Address: 745 FIFTH AVENUE NEW YORK State: NY Zip: 10151 City: 8. Deposit account number: (Attach duplicate copy of this page if paying by deposit account) Do not use this space 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. January 25, 2007 Paul A. Levy, Reg. No. 45,748 Signature Date Name of Person Signing Total number of pages including cover sheet, 01/30/2007 DBYRNE 00000126 11592482 attachments, and document: 01 FE:8021 40.00 OP Do not detach this portion Mail documents to be recorded with required cover sheet information to: Mail Stop Assignment Recordation Services

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ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

EVALUATION VALUE CALCULATING APPARATUS, RECORDING AND PLAYBACK APPARATUS, EVALUATION VALUE CALCULATING METHOD, RECORDING METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese Corporation, with offices at 7-35 Kitashinagawa 6-chome, Shinagawa-Ku, Tokyo, 141-0001, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/592,482, Filing Date: November 3, 2006.

This assignment executed on the dates indicated below.

Toshiki SHIMIZU	
Name of sole or 1st inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of sole or 1st inventor	
Joshik: Shimizer	January 15, 2007 Date of this assignment
Signature of sole or 1st inventor	Date of this assignment
Jumpei KURA	
Name of 2nd joint inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of 2nd joint inventor	
Jumpei Kura	Date of this assignment
Signature of 2nd joint inventor	Date of this astignment

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PATENT REEL: 018841 FRAME: 0252

ADDITIONAL INVENTORS

IVIATIKO PUNUTAIVIA	
Name of 3rd joint inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of 3rd joint inventor	
Mariko Frikuyama	January 17, 2007
Signature of 3rd joint inventor	Date of this assignment

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PATENT REEL: 018841 FRAME: 0253